TOSHIBA 1SS300

TOSHIBA DIODE SILICON EPITAXIAL PLANAR TYPE

155300

ULTRA HIGH SPEED SWITHING APPLICATION.

• Small Package : SC-70

• Low Forward Voltage : V_{F(3)}=0.92V (Typ.)

• Fast Reverse Recovery Time : $t_{rr} = 1.6$ ns (Typ.)

• Small Total Capacitance : C_T=2.2pF (Typ.)

MAXIMUM RATINGS (Ta = 25°C)

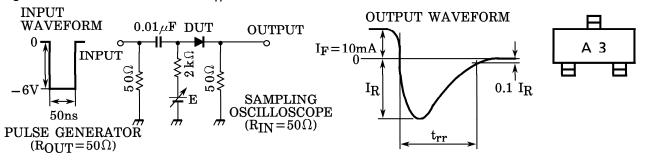
CHARACTERISTIC	SYMBOL	RATING	UNIT	
Maximum (Peak) Reverse Voltage	$V_{\mathbf{RM}}$	85	V	
Reverse Voltage	$V_{\mathbf{R}}$	80	V	
Maximum (Peak) Forward Current	I_{FM}	300 (*)	mA	
Average Forward Current	IO	100 (*)	mA	
Surge Current (10ms)	I_{FSM}	2 (*)	A	
Power Dissipation	P	100	mW	
Junction Temperature	T_{j}	125	°C	
Storage Temperature	$\mathrm{T_{stg}}$	-55~125	°C	

(*) Unit Rating. Total Rating=Unit Rating $\times 1.5$

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Forward Voltage	$V_{F(1)}$	I _F =1mA	_	0.61	_	V
	$V_{F(2)}$	$I_{\mathbf{F}} = 10 \text{mA}$	_	0.74	_	
	$V_{F(3)}$	$I_{\rm F}$ =100mA	_	0.92	1.20	
Reverse Current $ \frac{I_{R(1)}}{I_{R(2)}} $	$I_{R(1)}$	$V_R = 30V$	_	_	0.1	
	$V_R = 80V$	_	_	0.5	$\mu \mathbf{A}$	
Total Capacitance	C_{T}	$V_R=0$, f=1MHz	_	2.2	4.0	pF
Reverse Recovery Time	trr	$I_{ m F}\!=\!10{ m mA},~{ m Fig.1}$	_	1.6	4.0	ns

Fig.1 REVERSE RECOVERY TIME (trr) TEST CIRCUIT



961001EAA2

2.1±0.1 1.25±0.1 1.25±0.1 1.0+00-51.0 1. CATHODE 2. CATHODE 3. ANODE USM JEDEC —

EIAJ SC-70

1-2P1A

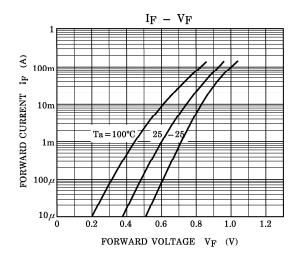
MARKING

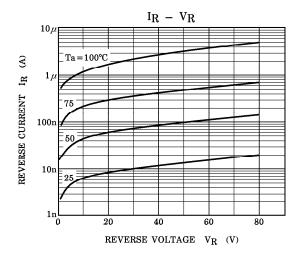
Unit in mm

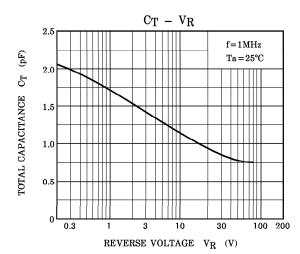
Weight: 0.006g

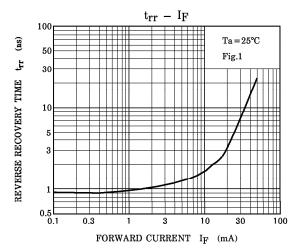
TOSHIBA

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